

Ultralow Power, Low Distortion, Fully Differential ADC Drivers

Data Sheet

ADA4940-1/ADA4940-2

FEATURES

Small signal bandwidth: 260 MHz **Ultralow power 1.25mA Extremely low harmonic distortion**

-122 dB THD at 50 kHz

-96 dB THD at 1 MHz

Low input voltage noise: 3.9 nV/√Hz 0.35 mV maximum offset voltage

Balanced outputs

Settling time to 0.1%: 34 ns

Rail-to-rail output: $-V_s + 0.1 \text{ V to } +V_s - 0.1 \text{ V}$ Adjustable output common-mode voltage Flexible power supplies: 3 V to 7 V (LFCSP) Disable pin to reduce power consumption ADA4940-1 is available in LFCSP and SOIC packages

APPLICATIONS

Low power PulSAR®/SAR ADC drivers Single-ended-to-differential conversion **Differential buffers Line drivers Medical imaging Industrial process controls** Portable electronics

GENERAL DESCRIPTION

The ADA4940-1/ADA4940-2 are low noise, low distortion fully differential amplifiers with very low power consumption. They are an ideal choice for driving low power, high resolution, high performance SAR and Σ - Δ analog-to-digital converters (ADCs) with resolutions up to 16 bits from dc to 1 MHz on only 1.25 mA of quiescent current. The adjustable level of the output commonmode voltage allows the ADA4940-1/ADA4940-2 to match the input common-mode voltage of multiple ADCs. The internal common-mode feedback loop provides exceptional output balance, as well as suppression of even-order harmonic distortion products.

With the ADA4940-1/ADA4940-2, differential gain configurations are easily realized with a simple external feedback network of four resistors determining the closed-loop gain of the amplifier. The ADA4940-1/ADA4940-2 are fabricated using Analog Devices, Inc., SiGe complementary bipolar process, enabling them to achieve very low levels of distortion with an input voltage noise of only 3.9 nV/√Hz. The low dc offset and excellent dynamic performance of the ADA4940-1/ADA4940-2 make them well suited for a variety of data acquisition and signal processing applications.

Document Feedback Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

FUNCTIONAL BLOCK DIAGRAMS

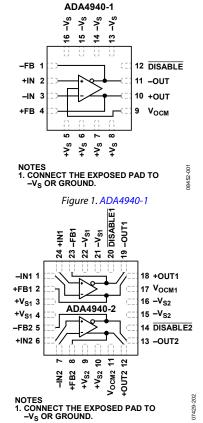


Figure 2. ADA4940-2

The ADA4940-1 is available in a 3 mm \times 3 mm, 16-lead LFCSP and an 8-lead SOIC. The ADA4940-2 is available in a 4 mm \times 4 mm, 24-lead LFCSP. The pinouts are optimized to facilitate printed circuit board (PCB) layout and minimize distortion. The ADA4940-1/ADA4940-2 are specified to operate over the −40°C to +125°C temperature range.

Table 1. Similar Products to ADA4940-1/ADA4940-2

Product	I _{SUPPLY} (mA)	Bandwidth (MHz)	Slew Rate (V/μs)	Noise (nV/√Hz)
AD8137	3	110	450	8.25
ADA4932-1	9	560	2800	3.6
ADA4941-1	2.2	31	22	5.1

Table 2. Complementary Products to ADA4940-1/ADA4940-2

Product	Power (mW)	Throughput (MSPS)	Resolution (Bits)	SNR (dB)
AD7982	7.0	1	18	98
AD7984	10.5	1.333	18	96.5
AD7621	65	3	16	88
AD7623	45	1.333	16	88

Data Sheet

TABLE OF CONTENTS

reatures	L
Applications	L
General Description	l
Functional Block Diagrams	l
Revision History	3
Specifications	1
$V_S = 5 \text{ V}$	1
$V_S = 3 V$	5
Absolute Maximum Ratings	3
Thermal Resistance	3
Maximum Power Dissipation	3
ESD Caution	3
Pin Configurations and Function Descriptions)
Typical Performance Characteristics	l
Test Circuits)
Terminology	l
Definition of Terms2	Ĺ
Theory of Operation	2

Applications Information
Analyzing an Application Circuit
Setting the Closed-Loop Gain
Estimating the Output Noise Voltage
Impact of Mismatches in the Feedback Networks 24
Calculating the Input Impedance of an Application Circuit 24
Input Common-Mode Voltage Range
Input and Output Capacitive AC Coupling26
Setting the Output Common-Mode Voltage
DISABLE Pin
Driving a Capacitive Load26
Driving a High Precision ADC27
Layout, Grounding, and Bypassing
ADA4940-1 LFCSP Example28
Outline Dimensions
Ordering Guide

Data Sheet

ADA4940-1/ADA4940-2

REVIS	SION I	HISTO	ORY
-------	--------	-------	-----

4/2018—Rev. D to Rev. E
Changes to Figure 2
Changes to Figure 610
Updated Outline Dimensions29
5/2016—Rev. C to Rev. D
Changes to Figure 1
Deleted Figure 2
Added Figure 2; Renumbered Sequentially
Updated Outline Dimensions29
Changes to Ordering Guide30
9/2013—Rev. B to Rev. C
Updated Outline Dimensions30
Changes to Ordering Guide31
3/2012—Rev. A to Rev. B
Reorganized Layout
Added ADA4940-1 8-Lead SOIC Package Universa
Changes to Features Section, Table 1, and Figure 1; Replaced Figure 2
Changed $V_s = \pm 2 \text{ V(or } +5 \text{ V)}$ Section to $V_s = +5 \text{ V}$ Section
Changes to $V_s = +5$ V Section and Table 3
Changes to Table 4 and Table 54
Changes to $V_S = 3$ V Section and Table 6
Changes to Table 7 and Table 8
Added Figure 5 and Table 12, Renumbered Sequentially
Changes to Figure 7, Figure 8, and Figure 910
Added Figure 15 and Figure 18; Changes to Figure 13,
Figure 14, and Figure 1611
Changes to Figure 19 and Figure 2012
Changes to Figure 25, Figure 26, and Figure 27; Added
Figure 28, Figure 29, and Figure 3013
Changes to Figure 31, Figure 32, Figure 33, Figure 34, Figure 35
and Figure 3614

Changes to Figure 37, Figure 38, Figure 39, and Figure 41	
Changes to Figure 49, Figure 50, and Figure 51	17
Added Figure 55 and Figure 57	18
Changes to Differential Vos, Differential CMRR, and Voca	
CMRR Section	20
Changes to Calculating the Input Impedance of an Application	on
Circuit Section	23
Changes to Figure 71	25
Changes to Driving a High Precision ADC Section and	
Figure 73	26
Changed ADA4940-1 Example Section to ADA4940-1 LFCS	P
Example Section	27
Changes to Ordering Guide	29
12/2011—Rev. 0 to Rev. A	
Changes to Features Section, General Description Section, ar	nd
Table 1	1
Replaced Figure 1 and Figure 2	1
Changes to $V_S = \pm 2.5 \text{ V (or } +5 \text{ V)}$ Section and Table 3	3
Changes to Table 6	
Replaced Figure 7, Figure 8, Figure 9, and Figure 10	
Replaced Figure 14, Figure 15, and Figure 17	10
Replaced Figure 24 and Figure 27	
Changes to Figure 37	
Replaced Figure 43 and Figure 46	
Replaced Figure 53	
Changes to Estimating the Output Noise Voltage Section, Table	
Table 15, and Calculating the Input Impedance of an Application	
Circuit Section	
Changes to Input Common-Mode Voltage Range Section	
Changes to Driving a High Precision ADC Section and	
Figure 65	24
0	

SPECIFICATIONS

$V_s = 5 V$

 V_{OCM} = midsupply, R_F = R_G = 1 k Ω , $R_{L,\,dm}$ = 1 k Ω , T_A = 25°C, LFCSP package, unless otherwise noted. T_{MIN} to T_{MAX} = -40°C to +125°C. (See Figure 61 for the definition of terms.)

$+D_{IN}$ or $-D_{IN}$ to $V_{OUT, dm}$ Performance

Table 3.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	$V_{OUT, dm} = 0.1 \text{ V p-p, G} = 1$		260		MHz
	$V_{OUT, dm} = 0.1 \text{ V p-p, G} = 2$		220		MHz
	$V_{OUT, dm} = 0.1 \text{ V p-p, G} = 5$		75		MHz
-3 dB Large Signal Bandwidth	$V_{OUT, dm} = 2 V p-p, G = 1$		25		MHz
	$V_{OUT, dm} = 2 V p-p, G = 2$		22		MHz
	$V_{OUT, dm} = 2 V p-p, G = 5$		19		MHz
Bandwidth for 0.1 dB Flatness	$V_{OUT, dm} = 2 V p-p, G = 1 and G = 2$		14.5		MHz
Slew Rate	$V_{OUT, dm} = 2 V step$		95		V/µs
Settling Time to 0.1%	$V_{OUT, dm} = 2 V step$		34		ns
Overdrive Recovery Time	$G = 2$, $V_{IN, dm} = 6 V p-p$, triangle wave		86		ns
NOISE/HARMONIC PERFORMANCE					
HD2/HD3	$V_{OUT, dm} = 2 \text{ V p-p, } f_C = 10 \text{ kHz}$		-125/-118		dBc
	$V_{OUT, dm} = 2 \text{ V p-p, } f_C = 50 \text{ kHz}$		-123/-126		dBc
	$V_{OUT, dm} = 2 \text{ V p-p, } f_C = 50 \text{ kHz, } G = 2$		-124/-117		dBc
	$V_{OUT, dm} = 2 \text{ V p-p, } f_C = 1 \text{ MHz}$		-102/-96		dBc
	$V_{OUT, dm} = 2 V p-p, f_C = 1 MHz, G = 2$		-100/-92		dBc
IMD3	$V_{OUT, dm} = 2 \text{ V p-p}, f_1 = 1.9 \text{ MHz}, f_2 = 2.1 \text{ MHz}$		-99		dBc
Input Voltage Noise	f = 100 kHz		3.9		nV/√Hz
Input Current Noise	f = 100 kHz		0.81		pA/√Hz
Crosstalk	$V_{OUT, dm} = 2 V p-p, f_C = 1 MHz$		-110		dB
INPUT CHARACTERISTICS					
Input Offset Voltage	$V_{IP} = V_{IN} = V_{OCM} = 0 V$	-0.35	±0.06	+0.35	mV
Input Offset Voltage Drift	T _{MIN} to T _{MAX}		1.2		μV/°C
Input Bias Current		-1.6	-1.1		μA
Input Bias Current Drift	T _{MIN} to T _{MAX}		-4.5		nA/°C
Input Offset Current		-500	±50	+500	nA
Input Common-Mode Voltage Range			$-V_{S} - 0.2$ to $+V_{S} - 1.2$		V
Input Resistance	Differential		33		kΩ
P	Common mode		50		ΜΩ
Input Capacitance			1		pF
Common-Mode Rejection Ratio (CMRR)	$\Delta V_{OS, dm}/\Delta V_{IN, cm}$, $\Delta V_{IN, cm} = \pm 1 \text{ V dc}$	86	119		dB
Open-Loop Gain		91	99		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	Each single-ended output	$-V_{S} + 0.1 \text{ to}$	$-V_s + 0.07$ to		V
caspat tomage string		$+V_S - 0.1$	$+V_S - 0.07$		
Linear Output Current	$f = 1 \text{ MHz}$, $R_{L,dm} = 22 \Omega$, $SFDR = -60 \text{ dBc}$		46		mA peak
Output Balance Error	$f = 1 \text{ MHz}, \Delta V_{OUT, cm} / \Delta V_{OUT, dm}$		–65	-60	dB

Data Sheet

V_{OCM} to V_{OUT, cm} Performance

Table 4.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
V _{OCM} DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	$V_{OUT, cm} = 0.1 \text{ V p-p}$		36		MHz
-3 dB Large Signal Bandwidth	V _{OUT, cm} = 1 V p-p		29		MHz
Slew Rate	V _{OUT, cm} = 1 V p-p		52		V/µs
Input Voltage Noise	f = 100 kHz		83		nV/√Hz
Gain	$\Delta V_{OUT, cm}/\Delta V_{OCM}$, $\Delta V_{OCM} = \pm 1 \text{ V}$	0.99	1	1.01	V/V
V _{OCM} CHARACTERISTICS					
Input Common-Mode Voltage Range			$-V_{s} + 0.8$ to		V
			$+V_{S}-0.7$		
Input Resistance			250		kΩ
Offset Voltage	$V_{OS, cm} = V_{OUT, cm} - V_{OCM}$; $V_{IP} = V_{IN} = V_{OCM} = 0 V$	-6	±1	+6	mV
Input Offset Voltage Drift	T _{MIN} to T _{MAX}		20		μV/°C
Input Bias Current		-7	+4	+7	μΑ
CMRR	$\Delta V_{OS, dm}/\Delta V_{OCM}$, $\Delta V_{OCM} = \pm 1 \text{ V}$	86	100		dB

General Performance

Table 5.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
POWER SUPPLY					
Operating Range	LFCSP	3		7	V
	SOIC	3		6	V
Quiescent Current per Amplifier	Enabled	1.05	1.25	1.38	mA
Quiescent Current Drift	T _{MIN} to T _{MAX}		4.25		μΑ/°C
	Disabled		13.5	28.5	μΑ
+PSRR	$\Delta V_{OS, dm}/\Delta V_S$, $\Delta V_S = 1 \text{ V p-p}$	80	90		dB
–PSRR	$\Delta V_{OS, dm}/\Delta V_S$, $\Delta V_S = 1 \text{ V p-p}$	80	96		dB
DISABLE (DISABLE PIN)					
DISABLE Input Voltage	Disabled		$\leq (-V_S + 1)$		V
	Enabled		$\geq (-V_S + 1.8)$		V
Turn-Off Time			10		μs
Turn-On Time			0.6		μs
DISABLE Pin Bias Current per Amplifier					
Enabled	DISABLE = +2.5 V		2	5	μΑ
Disabled	$\overline{\text{DISABLE}} = -2.5 \text{ V}$	-10	- 5		μΑ
OPERATING TEMPERATURE RANGE		-40		+125	°C

$V_s = 3 V$

 $V_{OCM} = midsupply, \ R_F = R_G = 1 \ k\Omega, \ R_{L,\,dm} = 1 \ k\Omega, \ T_A = 25 \ ^{\circ}C, \ LFCSP \ package, \ unless \ otherwise \ noted. \ T_{MIN} \ to \ T_{MAX} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C. \ (See \ Figure \ 61 \ for \ the \ definition \ of \ terms.)$

$+D_{IN}$ or $-D_{IN}$ to $V_{OUT, dm}$ Performance

Table 6.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE					
–3 dB Small Signal Bandwidth	$V_{OUT, dm} = 0.1 \text{ V p-p}$		240		MHz
	$V_{OUT, dm} = 0.1 \text{ V p-p, G} = 2$		200		MHz
	$V_{OUT, dm} = 0.1 \text{ V p-p, G} = 5$		70		MHz
–3 dB Large Signal Bandwidth	$V_{OUT, dm} = 2 V p-p$		24		MHz
	$V_{OUT, dm} = 2 V p-p, G = 2$		20		MHz
	$V_{OUT, dm} = 2 V p-p, G = 5$		17		MHz
Bandwidth for 0.1 dB Flatness	$V_{OUT, dm} = 0.1 \text{ V p-p}$		14		MHz
Slew Rate	$V_{OUT, dm} = 2 V step$		90		V/µs
Settling Time to 0.1%	$V_{OUT, dm} = 2 V step$		37		ns
Overdrive Recovery Time	$G = 2$, $V_{IN, dm} = 3.6 \text{ V p-p}$, triangle wave		85		ns
NOISE/HARMONIC PERFORMANCE					
HD2/HD3	$V_{OUT, dm} = 2 V p-p, f_C = 50 kHz (HD2/HD3)$		-115/-121		dBc
	$V_{OUT, dm} = 2 V p-p, f_C = 1 MHz (HD2/HD3)$		-104/-96		dBc
IMD3	$V_{OUT,dm} = 2 \text{ V p-p}, f_1 = 1.9 \text{ MHz}, f_2 = 2.1 \text{ MHz}$		-98		dBc
Input Voltage Noise	f = 100 kHz		3.9		nV/√Hz
Input Current Noise	f = 100 kHz		0.84		pA/√Hz
Crosstalk	$V_{OUT, dm} = 2 V p-p, f_C = 1 MHz$		-110		dB
INPUT CHARACTERISTICS					
Input Offset Voltage	$V_{IP} = V_{IN} = V_{OCM} = 1.5 \text{ V}$	-0.4	±0.06	+0.4	mV
Input Offset Voltage Drift	T _{MIN} to T _{MAX}		1.2		μV/°C
Input Bias Current		-1.6	-1.1		μΑ
Input Bias Current Drift	T _{MIN} to T _{MAX}		-4.5		nA/°C
Input Offset Current		-500	±50	+500	nA
Input Common-Mode Voltage Range			$-V_S - 0.2 \text{ to}$ $+V_S - 1.2$		V
Input Resistance	Differential		33		kΩ
•	Common mode		50		ΜΩ
Input Capacitance			1		pF
Common-Mode Rejection Ratio (CMRR)	$\Delta V_{OS, dm}/\Delta V_{IN, cm}$, $\Delta V_{IN, cm} = \pm 0.25 \text{ V dc}$	86	114		dB
Open-Loop Gain		91	99		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	Each single-ended output	$-V_s + 0.08$ to $+V_s - 0.08$	$-V_S + 0.04$ to $+V_S - 0.04$		V
Linear Output Current	$f = 1 \text{ MHz}$, $R_{L, dm} = 26 \Omega$, $SFDR = -60 \text{ dBc}$		38		mA peak
Output Balance Error	$f = 1 \text{ MHz}, \Delta V_{OUT, cm}/\Delta V_{OUT, dm}$		-65	-60	dB

Data Sheet

V_{OCM} to V_{OUT, cm} Performance

Table 7.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
V _{OCM} DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	$V_{OUT, cm} = 0.1 \text{ V p-p}$		36		MHz
-3 dB Large Signal Bandwidth	$V_{OUT, cm} = 1 V p-p$		26		MHz
Slew Rate	$V_{OUT, cm} = 1 V p-p$		48		V/µs
Input Voltage Noise	f = 100 kHz		92		nV/√Hz
Gain	$\Delta V_{OUT, cm}/\Delta V_{OCM}$, $\Delta V_{OCM} = \pm 0.25 V$	0.99	1	1.01	V/V
V _{OCM} CHARACTERISTICS					
Input Common-Mode Voltage Range			$-V_S + 0.8 \text{ to}$ $+V_S - 0.7$		V
Input Resistance			250		kΩ
Offset Voltage	$V_{OS, cm} = V_{OUT, cm} - V_{OCM}$; $V_{IP} = V_{IN} = V_{OCM} = 1.5 \text{ V}$	-7	±1	+7	mV
Input Offset Voltage Drift	T _{MIN} to T _{MAX}		20		μV/°C
Input Bias Current		-5	+1	+5	μΑ
CMRR	$\Delta V_{OS,dm}/\Delta V_{OCM}$, $\Delta V_{OCM} = \pm 0.25 V$	80	100		dB

General Performance

Table 8.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
POWER SUPPLY					
Operating Range	LFCSP	3		7	V
	SOIC	3		6	V
Quiescent Current per Amplifier	Enabled	1	1.18	1.33	mA
	T _{MIN} to T _{MAX}		4.25		μΑ/°C
	Disabled		7	22	μΑ
+PSRR	$\Delta V_{OS, dm}/\Delta V_S$, $\Delta V_S = 0.25 \text{ V p-p}$	80	90		dB
-PSRR	$\Delta V_{OS, dm}/\Delta V_S$, $\Delta V_S = 0.25 \text{ V p-p}$	80	96		dB
DISABLE (DISABLE PIN)					
DISABLE Input Voltage	Disabled		$\leq (-V_S + 1)$		V
	Enabled		$\geq (-V_S + 1.8)$		V
Turn-Off Time			16		μs
Turn-On Time			0.6		μs
DISABLE Pin Bias Current per Amplifier					
Enabled	DISABLE = +3 V		0.3	1	μΑ
Disabled	DISABLE = 0 V	-6	-3		μΑ
OPERATING TEMPERATURE RANGE		-40		+125	°C

ABSOLUTE MAXIMUM RATINGS

Table 9.

Parameter	Rating
Supply Voltage	8 V
V _{OCM}	±V _S
Differential Input Voltage	1.2 V
Operating Temperature Range	−40°C to +125°C
Storage Temperature Range	–65°C to +150°C
Lead Temperature (Soldering, 10 sec)	300°C
Junction Temperature	150°C
ESD	
Field Induced Charged Device Model (FICDM)	1250 V
Human Body Model (HBM)	2000 V

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, θ_{JA} is specified for the device soldered on a circuit board in still air.

Table 10.

Package Type	θ _{JA}	Unit
8-Lead SOIC (Single)/4-Layer Board	158	°C/W
16-Lead LFCSP (Single)/4-Layer Board	91.3	°C/W
24-Lead LFCSP (Dual)/4-Layer Board	65.1	°C/W

MAXIMUM POWER DISSIPATION

The maximum safe power dissipation in the ADA4940-1/ADA4940-2 packages is limited by the associated rise in junction temperature (T₁) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance of the ADA4940-1/ADA4940-2. Exceeding a junction temperature of 150°C for an extended period can result in changes in the silicon devices, potentially causing failure.

The power dissipated in the package (P_D) is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive for all outputs. The quiescent power dissipation is the voltage between the supply pins ($\pm V_S$) times the quiescent current (I_S). The load current consists of the differential and common-mode currents flowing to the load, as well as currents flowing through the external feedback networks and internal common-mode feedback loop. The internal resistor tap used in the common-mode feedback loop places a negligible differential load on the output. Consider rms voltages and currents when dealing with ac signals.

Airflow reduces θ_{JA} . In addition, more metal directly in contact with the package leads from metal traces, through holes, ground, and power planes reduces the θ_{JA} .

Figure 3 shows the maximum safe power dissipation in the package vs. the ambient temperature for the 8-lead SOIC (θ_{JA} = 158°C/W, single) the 16-lead LFCSP (θ_{JA} = 91.3°C/W, single) and 24-lead LFCSP (θ_{JA} = 65.1°C/W, dual) packages on a JEDEC standard 4-layer board. θ_{JA} values are approximations.

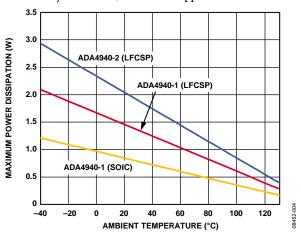


Figure 3. Maximum Safe Power Dissipation vs. Ambient Temperature

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

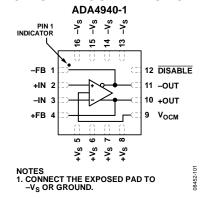


Figure 4. ADA4940-1 Pin Configuration (16-Lead LFCSP)

Table 11. ADA4940-1 Pin Function Descriptions (16-Lead LFCSP)

Pin No.	Mnemonic	Description
1	-FB	Negative Output for Feedback Component Connection.
2	+IN	Positive Input Summing Node.
3	-IN	Negative Input Summing Node.
4	+FB	Positive Output for Feedback Component Connection.
5 to 8	+V _S	Positive Supply Voltage.
9	V _{ОСМ}	Output Common-Mode Voltage.
10	+OUT	Positive Output for Load Connection.
11	-OUT	Negative Output for Load Connection.
12	DISABLE	Disable Pin.
13 to 16	-V _s	Negative Supply Voltage.
	Exposed pad (EPAD)	Connect the exposed pad to $-V_s$ or ground.

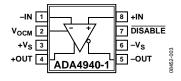


Figure 5. ADA4940-1 Pin Configuration (8-Lead SOIC)

Table 12. ADA4940-1 Pin Function Descriptions (8-Lead SOIC)

Pin No.	Mnemonic	Description
1	-IN	Negative Input Summing Node
2	V _{осм}	Output Common-Mode Voltage
3	+V _S	Positive Supply Voltage
4	+OUT	Positive Output for Load Connection
5	-OUT	Negative Output for Load Connection
6	-V _S	Negative Supply Voltage
7	DISABLE	Disable Pin
8	+IN	Positive Input Summing Node

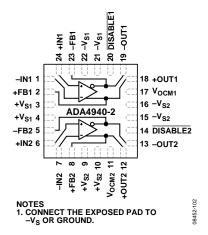


Figure 6. ADA4940-2 Pin Configuration (24-Lead LFCSP)

Table 13. ADA4940-2 Pin Function Descriptions (24-Lead LFCSP)

Pin No.	Mnemonic	Description
1	-IN1	Negative Input Summing Node 1.
2	+FB1	Positive Output Feedback Pin 1.
3, 4	+V _{S1}	Positive Supply Voltage 1.
5	-FB2	Negative Output Feedback Pin 2.
6	+IN2	Positive Input Summing Node 2.
7	-IN2	Negative Input Summing Node 2.
8	+FB2	Positive Output Feedback Pin 2.
9, 10	+V ₅₂	Positive Supply Voltage 2.
11	V _{OCM2}	Output Common-Mode Voltage 2.
12	+OUT2	Positive Output 2.
13	-OUT2	Negative Output 2.
14	DISABLE2	Disable Pin 2.
15, 16	-V ₅₂	Negative Supply Voltage 2.
17	V осм1	Output Common-Mode Voltage 1.
18	+OUT1	Positive Output 1.
19	-OUT1	Negative Output 1.
20	DISABLE1	Disable Pin 1.
21, 22	-V ₅₁	Negative Supply Voltage 1.
23	-FB1	Negative Output Feedback Pin 1.
24	+IN1	Positive Input Summing Node 1.
	Exposed pad (EPAD)	Connect the exposed pad to −V _s or ground.

TYPICAL PERFORMANCE CHARACTERISTICS

 $T_A = 25$ °C, $V_S = \pm 2.5$ V, G = 1, $R_F = R_G = 1$ k Ω , $R_T = 52.3$ Ω (when used), $R_L = 1$ k Ω , unless otherwise noted. See Figure 59 and Figure 60 for the test circuits.

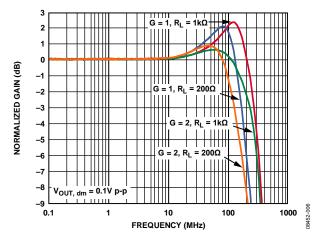


Figure 7. Small Signal Frequency Response for Various Gains and Loads (LFCSP)

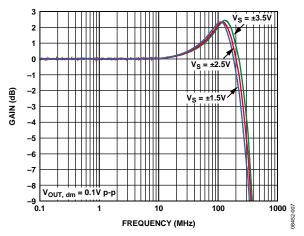


Figure 8. Small Signal Frequency Response for Various Supplies (LFCSP)

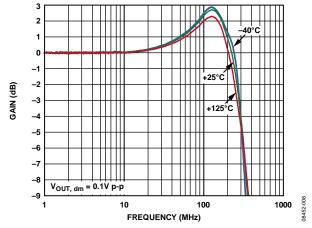


Figure 9. Small Signal Frequency Response for Various Temperatures (LFCSP)

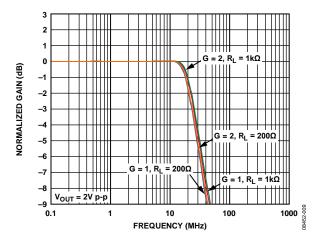


Figure 10. Large Signal Frequency Response for Various Gains and Loads

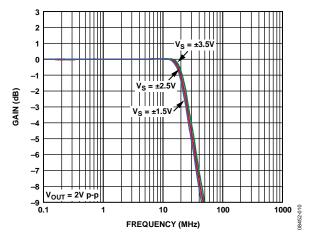


Figure 11. Large Signal Frequency Response for Various Supplies

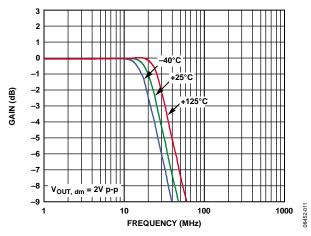


Figure 12. Large Signal Frequency Response for Various Temperatures

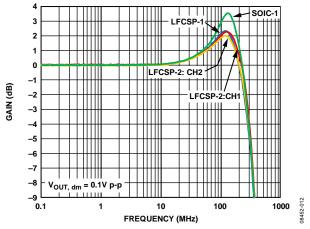


Figure 13. Small Signal Frequency Response for Various Packages

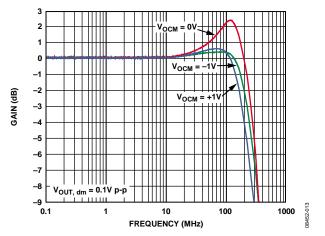


Figure 14. Small Signal Frequency Response at Various V_{OCM} Levels (LFCSP)

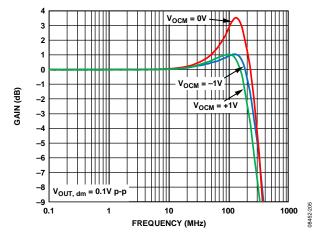


Figure 15. Small Signal Frequency Response for Various V_{OCM} (SOIC)

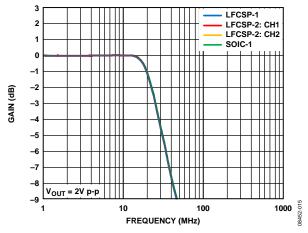


Figure 16. Large Signal Frequency Response for Various Packages

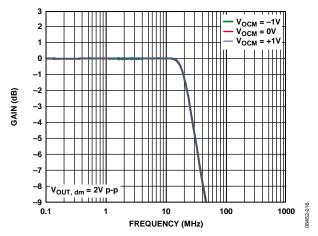


Figure 17. Large Signal Frequency Response at Various V_{OCM} Levels

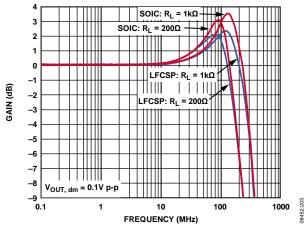


Figure 18. Small Signal Frequency Response for Various Packages and Loads

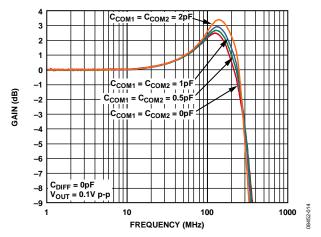


Figure 19. Small Signal Frequency Response for Various Capacitive Loads (LFCSP)

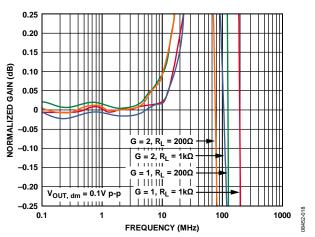


Figure 20. 0.1 dB Flatness Small Signal Frequency Response for Various Gains and Loads (LFCSP)

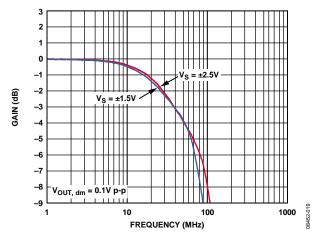


Figure 21. V_{OCM} Small Signal Frequency Response for Various Supplies

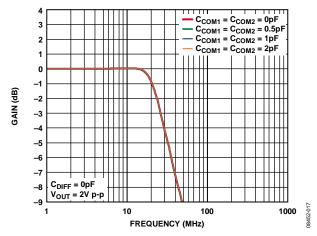


Figure 22. Large Signal Frequency Response for Various Capacitive Loads

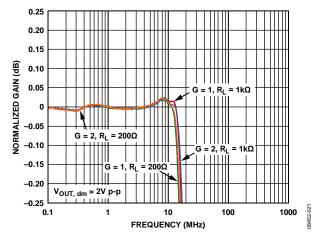


Figure 23. 0.1 dB Flatness Large Signal Frequency Response for Various Gains and Loads

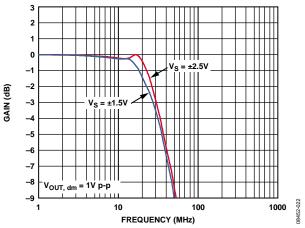


Figure 24. Vocm Large Signal Frequency Response for Various Supplies

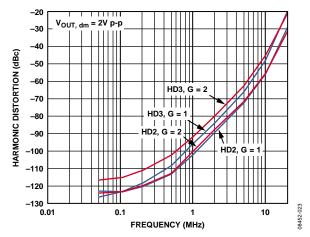


Figure 25. Harmonic Distortion vs. Frequency for Various Gains (LFCSP)

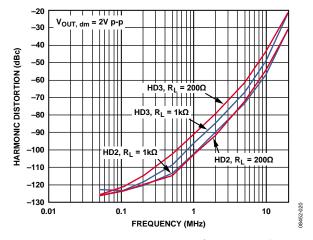
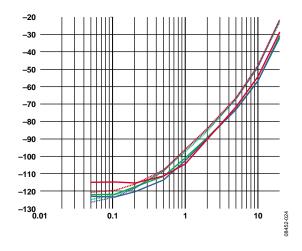


Figure 26. Harmonic Distortion vs. Frequency for Various Loads (LFCSP)



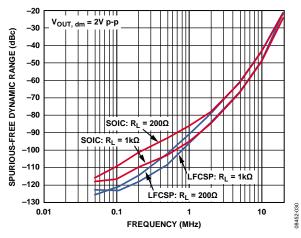


Figure 31. Spurious-Free Dynamic Range vs. Frequency at $R_L=200\,\Omega\,and\,R_L=1\,k\Omega$

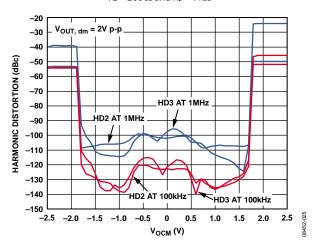


Figure 32. Harmonic Distortion vs. V_{OCM} for 100 kHz and 1 MHz, ± 2.5 V Supplies (LFCSP)

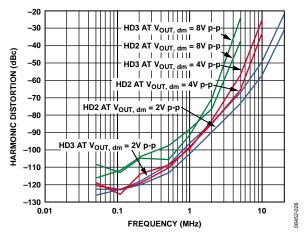


Figure 33. Harmonic Distortion vs. Frequency for Various V_{OUT, dm} (LFCSP)

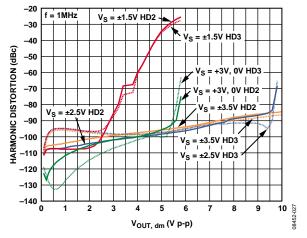


Figure 34. Harmonic Distortion vs. $V_{OUT,dm}$ for Various Supplies, f = 1 MHz (LFCSP)

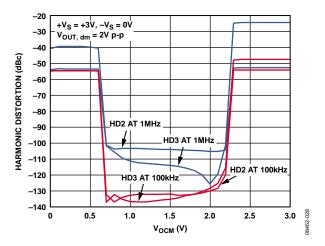


Figure 35. Harmonic Distortion vs. V_{OCM} for 100 kHz and 1 MHz, 3 V Supply (LFCSP)

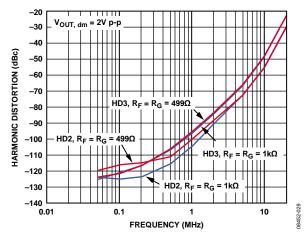


Figure 36. Harmonic Distortion vs. Frequency for Various R_F and R_G (LFCSP)

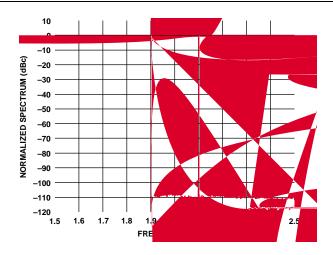
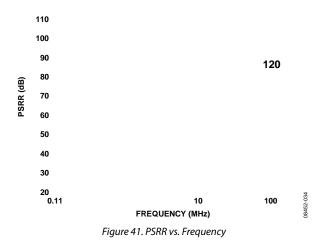


Figure 40. Crosstalk vs. Frequency, ADA4940-2



100 -15 90 80 -30 70 -45 60 -60 50 GAIN (dB) 40 30 -120 B -135 H 20 10 -150 -10 -165 -20 -180 -30 -195 -40 └ 10k -210 10M 100M 1G FREQUENCY (Hz)

Figure 42. Open-Loop Gain and Phase vs. Frequency

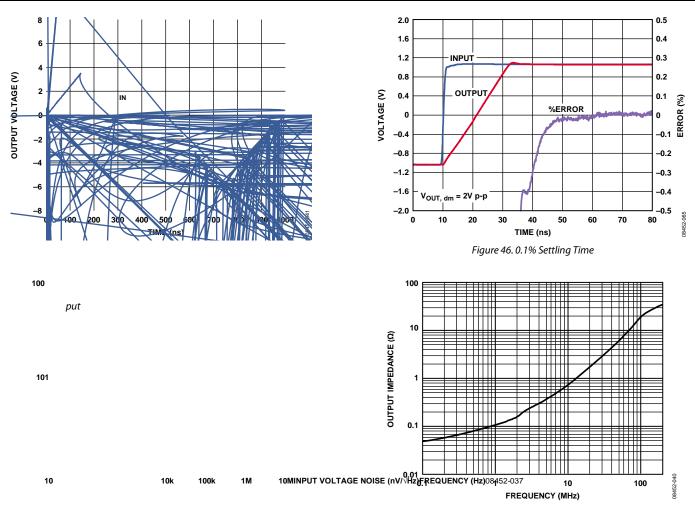


Figure 44. Voltage Noise Spectral Density, Referred to In

OUT, V_{ICM} = 1V

| OUT, V_{ICM} = 1V | OUT, V_{ICM} = 1V | OUT, V_{ICM} = 1V | OUT, V_{ICM} = 1V | OUT, V_{ICM} = 1V

Figure 45. DISABLE Pin Turn-Off Time

Figure 47. Closed-Loop Output Impedance Magnitude vs. Frequency, G = 1

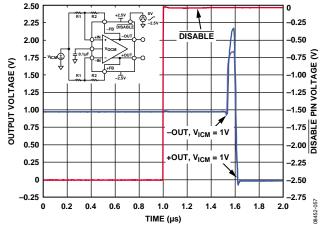


Figure 48. DISABLE Pin Turn-On Time

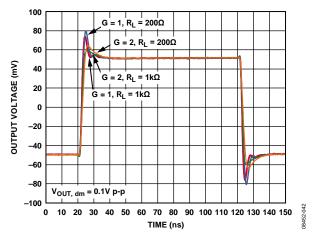


Figure 49. Small Signal Transient Response for Various Gains and Loads (LFCSP)

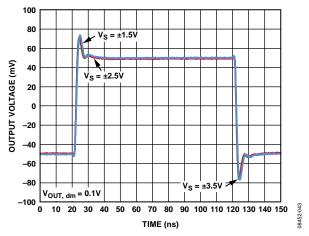


Figure 50. Small Signal Transient Response for Various Supplies (LFCSP)

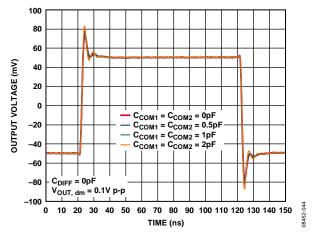
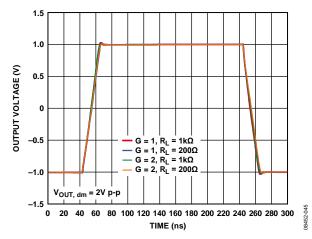


Figure 51. Small Signal Transient Response for Various Capacitive Loads (LFCSP)



 ${\it Figure 52. Large Signal Transient Response for Various Gains and Loads}$

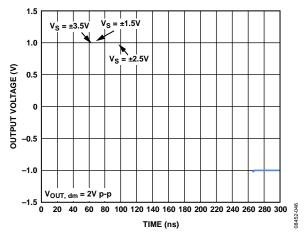


Figure 53. Large Signal Transient Response for Various Supplies

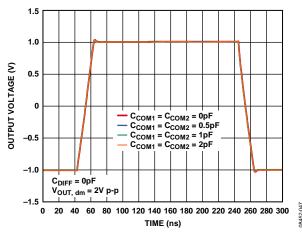


Figure 54. Large Signal Transient Response for Various Capacitive Loads

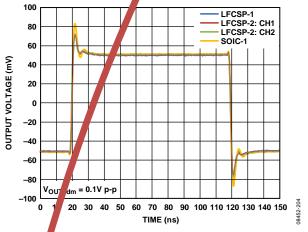


Figure 55. Shall Signal Transient Response for Various Packages, $C_L = 0$ pF

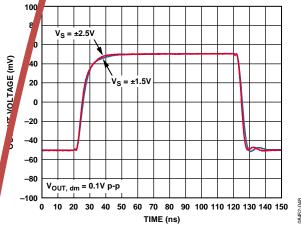
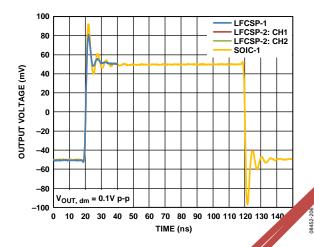


Figure 56. V_{OCM} Small Signal Transient Response



TEST CIRCUITS

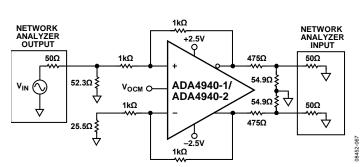


Figure 59. Equivalent Basic Test Circuit

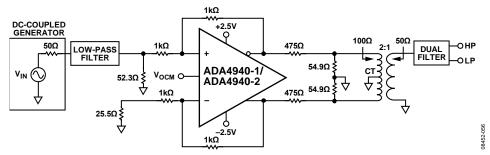


Figure 60. Test Circuit for Distortion Measurements

TERMINOLOGY DEFINITION OF TERMS

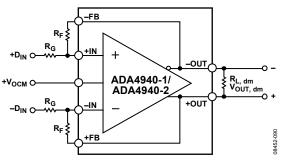


Figure 61. Circuit Definitions

Differential Voltage

Differential voltage refers to the difference between two node voltages. For example, the differential output voltage (or equivalently, output differential mode voltage) is defined as

$$V_{OUT, dm} = (V_{+OUT} - V_{-OUT})$$

where V_{+OUT} and V_{-OUT} refer to the voltages at the +OUT and -OUT terminals with respect to a common reference.

Similarly, the differential input voltage is defined as

$$V_{IN, dm} = (+D_{IN} - (-D_{IN}))$$

Common-Mode Voltage (CMV)

CMV refers to the average of two node voltages. The output common-mode voltage is defined as

$$V_{OUT, cm} = (V_{+OUT} + V_{-OUT})/2$$

Similarly, the input common-mode voltage is defined as

$$V_{IN, cm} = (+D_{IN} + (-D_{IN}))/2$$

Common-Mode Offset Voltage

The common-mode offset voltage is defined as the difference between the voltage applied to the V_{OCM} terminal and the common mode of the output voltage.

$$V_{OS, cm} = V_{OUT, cm} - V_{OCM}$$

Differential Vos, Differential CMRR, and Vocm CMRR

The differential mode and common-mode voltages each have their own error sources. The differential offset ($V_{OS,\,dm}$) is the voltage error between the +IN and –IN terminals of the amplifier. Differential CMRR reflects the change of $V_{OS,\,dm}$ in response to changes to the common-mode voltage at the input terminals +D_{IN} and –D_{IN}.

$$CMRR_{DIFF} = \frac{V_{IN, cm}}{V_{OS, dm}}$$

 $V_{\text{OCM}} \ CMRR \ reflects \ the \ change \ of \ V_{\text{OS, dm}} \ in \ response \ to \\ changes \ to \ the \ common-mode \ voltage \ at \ the \ output \ terminals.$

$$CMRR_{V_{OCM}} = \frac{V_{OCM}}{V_{OS,dm}}$$

Balance

Balance is a measure of how well the differential signals are matched in amplitude; the differential signals are exactly 180° apart in phase. By this definition, the output balance is the magnitude of the output common-mode voltage divided by the magnitude of the output differential mode voltage.

Output B l nce Error =
$$\frac{\left| V_{OUT, cm} \right|}{\left| V_{OUT, dm} \right|}$$

THEORY OF OPERATION

The ADA4940-1/ADA4940-2 are high speed, low power differential amplifiers fabricated on Analog Devices advanced dielectrically isolated SiGe bipolar process. They provide two closely balanced differential outputs in response to either differential or single-ended input signals. An external feedback network that is similar to a voltage feedback operational amplifier sets the differential gain. The output common-mode voltage is independent of the input common-mode voltage and is set by an external voltage at the $V_{\rm OCM}$ terminal. The PNP input stage allows input common-mode voltages between the negative supply and 1.2 V below the positive supply. A rail-to-rail output stage supplies a wide output voltage range. The $\overline{\rm DISABLE}$ pin can reduce the supply current of the amplifier to 13.5 μ A.

Figure 62 shows the ADA4940-1/ADA4940-2 architecture. The differential feedback loop consists of the differential transconductance $G_{\rm DIFF}$ working through the $G_{\rm O}$ output buffers and the $R_{\rm F}/R_{\rm G}$ feedback networks. The common-mode feedback loop is set up with a voltage divider across the two differential outputs to create an output voltage midpoint and a common-mode transconductance, $G_{\rm CM}$.

APPLICATIONS INFORMATION

ANALYZING AN APPLICATION CIRCUIT

The ADA4940-1/ADA4940-2 use open-loop gain and negative feedback to force their differential and common-mode output voltages in such a way as to minimize the differential and common-mode error voltages. The differential error voltage is defined as the voltage between the differential inputs labeled +IN and –IN (see Figure 61). For most purposes, this voltage is zero. Similarly, the difference between the actual output common-mode voltage and the voltage applied to $V_{\rm OCM}$ is also zero. Starting from these two assumptions, any application circuit can be analyzed.

SETTING THE CLOSED-LOOP GAIN

Determine the differential mode gain of the circuit in Figure 61 by using the following equation:

$$\left| \frac{V_{OUT,\,dm}}{V_{IN,\,dm}} \right| = \frac{R_F}{R_G}$$

This assumes that the input resistors (R_G) and feedback resistors (R_F) on each side are equal.

ESTIMATING THE OUTPUT NOISE VOLTAGE

Estimate the differential output noise of the ADA4940-1/ ADA4940-2 by using the noise model in Figure 63. The input-referred noise voltage density, $v_{\rm nIN}$, is modeled as a differential input, and the noise currents, $i_{\rm nIN-}$ and $i_{\rm nIN+}$, appear between each input and ground. The noise currents are assumed equal and produce a voltage across the parallel combination of the gain and feedback resistances. $v_{\rm nCM}$ is the noise voltage density at the $V_{\rm OCM}$ pin. Each of the four resistors contributes (4kTRx) $^{1/2}$. Table 14 summarizes the input noise sources, the multiplication factors, and the output-referred noise density terms. For more noise calculation information, go to the Analog Devices Differential Amplifier Calculator (DiffAmpCalc^m), click

ADIDiffAmpCalculator.zip, and follow the on-screen prompts.

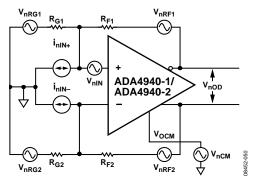


Figure 63. ADA4940-1/ADA4940-2 Noise Model

As with conventional op amp, the output noise voltage densities can be estimated by multiplying the input-referred terms at +IN and –IN by the appropriate output factor,

where

$$G_N = \frac{2}{(\beta_1 + \beta_2)}$$
 is the circuit noise gain.

$$\beta_I = \frac{R_{GI}}{R_{FI} + R_{GI}}$$
 and $\beta_2 = \frac{R_{G2}}{R_{F2} + R_{G2}}$ are the feedback factors.

When $R_{F1}/R_{G1}=R_{F2}/R_{G2}$, then $\beta 1=\beta 2=\beta$, and the noise gain becomes

$$G_N = \frac{1}{\beta} = 1 + \frac{R_F}{R_C}$$

Note that the output noise from V_{OCM} goes to zero in this case. The total differential output noise density, v_{nOD} , is the root-sumsquare of the individual output noise terms.

$$v_{nOD} = \sqrt{\sum_{i=1}^{8} v_{nOi}^2}$$

Table 14. Output Noise Voltage Density Calculations

Input Noise Contribution	Input Noise Term	Input Noise Voltage Density	Output Multiplication Factor	Output-Referred Noise Voltage Density Term
Differential Input	V _{nIN}	V _{nIN}	G _N	$v_{nO1} = G_N (v_{nIN})$
Inverting Input	i _{nIN} _	$i_{nIN-} \times (R_{G2} R_{F2})$	G_N	$v_{nO2} = G_N [i_{nIN-} \times (R_{G2} R_{F2})]$
Noninverting Input	i _{nIN+}	$i_{nIN+} \times (R_{G1} R_{F1})$	G _N	$v_{nO3} = G_N [i_{nIN+} \times (R_{G1} R_{F1})]$
V _{OCM} Input	V _{nCM}	V _{nCM}	$G_N (\beta_1 - \beta_2)$	$v_{nO4} = G_N (\beta_1 - \beta_2)(v_{nCM})$
Gain Resistor R _{G1}	VnRG1	(4kTR _{G1}) ^{1/2}	$G_N (1 - \beta_2)$	$v_{nO5} = G_N (1 - \beta_2)(4kTR_{G1})^{1/2}$
Gain Resistor R _{G2}	V _{nRG2}	(4kTR _{G2}) ^{1/2}	$G_N (1 - \beta_1)$	$v_{nO6} = G_N (1 - \beta_1)(4kTR_{G2})^{1/2}$
Feedback Resistor R _{F1}	V _{nRF1}	(4kTR _{F1}) ^{1/2}	1	$v_{nO7} = (4kTR_{F1})^{1/2}$
Feedback Resistor R _{F2}	VnRF2	(4kTR _{F2}) ^{1/2}	1	$v_{nO8} = (4kTR_{F2})^{1/2}$

Table 15 and Table 16 list several common gain settings, recommended resistor values, input impedances, and output noise density for both balanced and unbalanced input configurations.

Table 15. Differential Ground-Referenced Input, DC-Coupled, R_L = 1 k Ω (See Figure 64)

Nominal Gain (dB)	$R_F(\Omega)$	$R_G(\Omega)$	$R_{IN, dm}(\Omega)$	Differential Output Noise Density (nV/√Hz)	RTI (nV/√Hz)
0	1000	1000	2000	11.3	11.3
6	1000	500	1000	15.4	7.7
10	1000	318	636	20.0	6.8
14	1000	196	392	27.7	5.5

Table 16. Single-Ended Ground-Referenced Input, DC-Coupled, $R_S = 50 \Omega$, $R_L = 1 k\Omega$ (See Figure 65)

Nominal Gain (dB)	R _F (Ω)	R _G (Ω)	R _T (Ω)	$R_{IN, se}(\Omega)$	$R_{G1}(\Omega)^1$	Differential Output Noise Density (nV/√Hz)	RTI (nV/√Hz)
0	1000	1000	52.3	1333	1025	11.2	11.2
6	1000	500	53.6	750	526	15.0	7.5
10	1000	318	54.9	512	344	19.0	6.3
14	1000	196	59.0	337	223	25.3	5

 $^{^{1}}R_{G1} = R_{G} + (R_{S} || R_{T})$

Terminating a Single-Ended Input

This section describes how to properly terminate a single-ended input to the ADA4940-1/ADA4940-2 with a gain of 1, $R_{\text{F}}=1~\text{k}\Omega$ and $R_{\text{G}}=1~\text{k}\Omega$. An example using an input source with a terminated output voltage of 1 V p-p and source resistance of 50 Ω illustrates the three steps that must be followed. Because the terminated output voltage of the source is 1 V p-p, the open-circuit output voltage of the source is 2 V p-p. The source shown in Figure 66 indicates this open-circuit voltage.

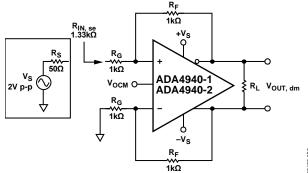


Figure 66. Calculating Single-Ended Input Impedance, R_{IN}

1. The input impedance is calculated by

$$R_{IN, se} = \left(\frac{R_G}{1 - \frac{R_F}{2 \times (R_G + R_F)}}\right) = \left(\frac{1000}{1 - \frac{1000}{2 \times (1000 + 1000)}}\right) = 1.33 \text{ kG}$$

2. To match the 50 Ω source resistance, calculate the termination resistor, R_T , using $R_T || 1.33 \text{ k}\Omega = 50 \Omega$. The closest standard 1% value for R_T is 52.3 Ω .

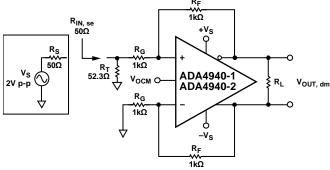
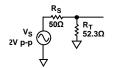


Figure 67. Adding Termination Resistor R_T

3. Figure 67 shows that the effective R_G in the upper feedback loop is now greater than the R_G in the lower loop due to the addition of the termination resistors. To compensate for the imbalance of the gain resistors, add a correction resistor (R_{TS}) in series with R_G in the lower loop. R_{TS} is the Thevenin equivalent of the source resistance, R_S , and the termination resistance, R_T , and is equal to $R_S || R_T$.





INPUT AND OUTPUT CAPACITIVE AC COUPLING

Although the ADA4940-1/ADA4940-2 is best suited to dc-coupled applications, it is nonetheless possible to use it in accoupled circuits. Input ac coupling capacitors can be inserted between the source and $R_{\rm G}$. This ac coupling blocks the flow of the dc common-mode feedback current and causes the ADA4940-1/ADA4940-2 dc input common-mode voltage to equal the dc output common-mode voltage. These ac coupling capacitors must be placed in both loops to keep the feedback factors matched. Output ac coupling capacitors can be placed in series between each output and its respective load.

SETTING THE OUTPUT COMMON-MODE VOLTAGE

The V_{OCM} pin of the ADA4940-1/ADA4940-2 is internally biased at a voltage approximately equal to the midsupply point, $[(+V_s) + (-V_s)]/2$. Relying on this internal bias results in an output common-mode voltage that is within approximately 100 mV of the expected value.

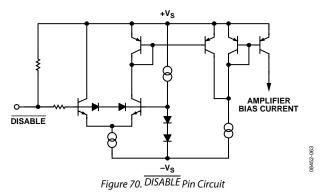
In cases where more accurate control of the output common-mode level is required, it is recommended that an external source, or resistor divider (10 k Ω or greater resistors), be used. The output common-mode offset listed in the Specifications section assumes that the V_{OCM} input is driven by a low impedance voltage source.

It is also possible to connect the V_{OCM} input to a common-mode level (CML) output of an ADC. However, care must be taken to ensure that the output has sufficient drive capability. The input impedance of the V_{OCM} pin is approximately 250 k Ω .

DISABLE PIN

The ADA4940-1/ADA4940-2 feature a $\overline{DISABLE}$ pin that can be used to minimize the quiescent current consumed when the device is not being used. $\overline{DISABLE}$ is asserted by applying a low logic level to the $\overline{DISABLE}$ pin. The threshold between high and low logic levels is nominally 1.4 V above the negative supply rail. See Table 5 and Table 8 for the threshold limits.

The DISABLE pin features an internal pull-up network that enables the amplifier for normal operation. The ADA4940-1/ADA4940-2 DISABLE pin can be left floating (that is, no external connection is required) and does not require an external pull-up resistor to ensure normal on operation (see Figure 70). When the ADA4940-1/ADA4940-2 is disabled, the output is high impedance. Note that the outputs are tied to the inputs through the feedback resistors and to the source using the gain resistors. In addition, there are back-to-back diodes on the input pins that limit the differential voltage to 1.2 V.



DRIVING A CAPACITIVE LOAD

A purely capacitive load reacts with the bond wire and pin inductance of the ADA4940-1/ADA4940-2, resulting in high frequency ringing in the transient response and loss of phase margin. One way to minimize this effect is to place a resistor in series with each output to buffer the load capacitance. The resistor and load capacitance form a first-order, low-pass filter; therefore, the resistor value must be as small as possible. In some cases, the ADCs require small series resistors to be added on their inputs.

Figure 71 illustrates the capacitive load vs. the series resistance required to maintain a minimum 45° of phase margin.

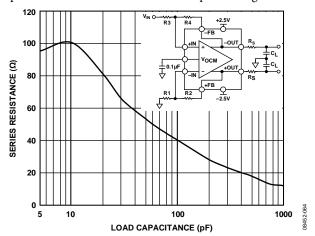


Figure 71. Capacitive Load vs. Series Resistance (LFCSP)

DRIVING A HIGH PRECISION ADC

The ADA4940-1/ADA4940-2 are ideally suited for broadband dc-coupled applications. The circuit in Figure 73 shows a frontend connection for an ADA4940-1 driving an AD7982, which is an 18-bit, 1 MSPS successive approximation, analog-to-digital converter (ADC) that operates from a single power supply, 3 V to 5 V. It contains a low power, high speed, 18-bit sampling ADC and a versatile serial interface port. The reference voltage, REF, is applied externally and can be set independent of the supply voltage. As shown in Figure 73, the ADA4940-1 is dccoupled on the input and the output, which eliminates the need for a transformer to drive the ADC. The amplifier performs a single-ended-to-differential conversion if needed and level shifts the input signal to match the input common mode of the ADC. The ADA4940-1 is configured with a dual 7 V supply (+6 V and -1 V) and a gain that is set by the ratio of the feedback resistor to the gain resistor. In addition, the circuit can be used in a single-ended-input-to-differential output or differential-input-to-differential output configuration. If needed, a termination resistor in parallel with the source input can be used. Whether the input is a single-ended input or differential, the input impedance of the amplifier can be calculated as shown in the Terminating a Single-Ended Input section. If R1 = R2 = R3 = $R4 = 1 \text{ k}\Omega$, the single-ended input impedance is approximately 1.33 k Ω , which, in parallel with a 52.3 Ω termination resistor, provides a 50 Ω termination for the source. An additional 25.5 Ω (1025.5 Ω total) at the inverting input balances the parallel impedance of the 50 Ω source and the termination resistor driving the noninverting input. However, if a differential source input is used, the differential input impedance is 2 k Ω . In this case, two 52.3 Ω termination resistors are used to terminate the inputs.

In this example, the signal generator has a 10 V p-p symmetric, ground-referenced bipolar output. The V_{OCM} input is bypassed for noise reduction and set externally with 1% resistors to 2.5 V to maximize the output dynamic range. With an output common-

mode voltage of 2.5 V, each ADA4940-1 output swings between 0 V and 5 V, opposite in phase, providing a gain of 1 and a 10 V p-p differential signal to the ADC input. The differential RC section between the ADA4940-1 output and the ADC provides single-pole, low-pass filtering with a corner frequency of 1.79 MHz and extra buffering for the current spikes that are output from the ADC input when its sample-and-hold (SHA) capacitors are discharged.

The total system power in Figure 73 is under 35 mW. A large portion of that power is the current coming from supplies to the output, which is set at 2.5 V, going back to the input through the feedback and gain resistors. To reduce that power to 25 mW, increase the value of the feedback and gain resistor from 1 k Ω to 2 k Ω and set the value of the resistors R5 and R6 to 3 k Ω . The ADR435 is used to regulate the +6 V supply to +5 V, which ends up powering the ADC and setting the reference voltage for the V_{OCM} pin.

Figure 72 shows the FFT of a 20 kHz differential input tone sampled at 1 MSPS. The second and third harmonics are down at -118 dBc and -122 dBc.

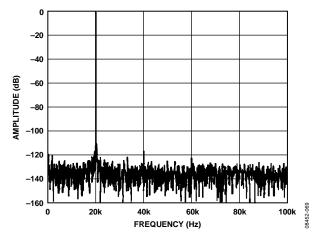
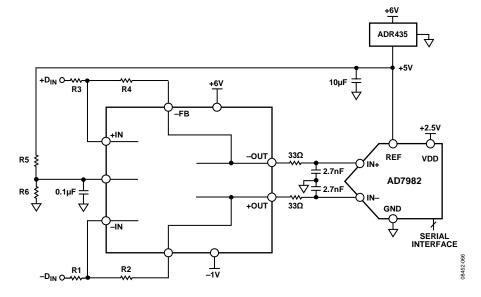


Figure 72. Distortion Measurement of a 20 kHz Input Tone (See CN-0237)



LAYOUT, GROUNDING, AND BYPASSING

As a high speed device, the ADA4940-1/ADA4940-2 are sensitive to the PCB environment in which they operate. Realizing their superior performance requires attention to the details of high speed PCB design.

ADA4940-1 LFCSP EXAMPLE

The first requirement is a solid ground plane that covers as much of the board area around the ADA4940-1 as possible. However, clear the area near the feedback resistors (R_F), gain resistors (R_G), and the input summing nodes (Pin 2 and Pin 3) of all ground and power planes (see Figure 74). Clearing the ground and power planes minimizes any stray capacitance at these nodes and prevents peaking of the response of the amplifier at high frequencies.

The thermal resistance, θ_{JA} , is specified for the device, including the exposed pad, soldered to a high thermal conductivity 4-layer circuit board, as described in EIA/JESD 51-7.

Bypass the power supply pins as close to the device as possible and directly to a nearby ground plane. Use high frequency ceramic chip capacitors. Use two parallel bypass capacitors (1000 pF and 0.1 $\mu F)$ for each supply. Place the 1000 pF capacitor closer to the device. Further away, provide low frequency bypassing using 10 μF tantalum capacitors from each supply to ground.

Ensure that signal routing is short and direct to avoid parasitic effects. Wherever complementary signals exist, provide a symmetrical layout to maximize balanced performance. When routing differential signals over a long distance, ensure that PCB traces are close together, and twist any differential wiring such that loop area is minimized. Doing this reduces radiated energy and makes the circuit less susceptible to interference.

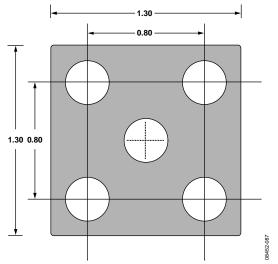


Figure 75. Recommended PCB Thermal Attach Pad Dimensions (mm)

Figure 74. Ground and Power Plane Voiding in Vicinity of R_F and R_G

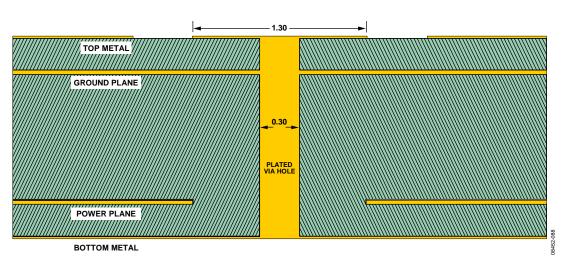
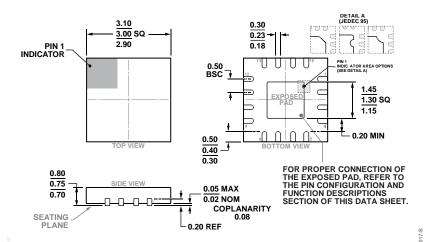


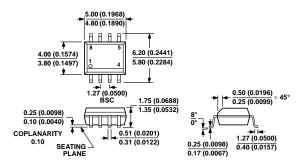
Figure 76. Cross-Section of 4-Layer PCB Showing Thermal Via Connection to Buried Ground Plane (Dimensions in mm)

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WEED-6

Figure 77. 16-Lead Lead Frame Chip Scale Package [LFCSP] 3 mm × 3 mm Body and 0.75 mm Package Height (CP-16-21) Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MS-012-AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 78. 8-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-8) Dimensions shown in millimeters and (inches)

Rev. E | Page 29 of 30

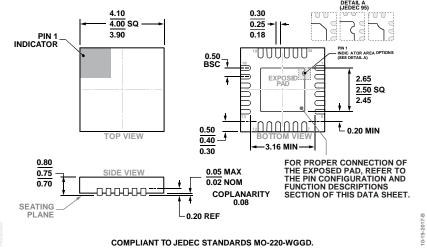


Figure 79. 24-Lead Lead Frame Chip Scale Package [LFCSP] 4 mm × 4 mm Body and 0.75 mm Package Height (CP-24-7) Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option	Ordering Quantity	Marking Code			
ADA4940-1ACPZ-R2	−40°C to +125°C	16-Lead LFCSP	CP-16-21	250	H29			
ADA4940-1ACPZ-RL	-40°C to +125°C	16-Lead LFCSP	CP-16-21	5,000	H29			
ADA4940-1ACPZ-R7	-40°C to +125°C	16-Lead LFCSP	CP-16-21	1,500	H29			
ADA4940-1ARZ	-40°C to +125°C	8-Lead SOIC_N	R-8	98				
ADA4940-1ARZ-RL	-40°C to +125°C	8-Lead SOIC_N	R-8	2,500				
ADA4940-1ARZ-R7	-40°C to +125°C	8-Lead SOIC_N	R-8	1,000				
ADA4940-2ACPZ-R2	−40°C to +125°C	24-Lead LFCSP	CP-24-7	250				
ADA4940-2ACPZ-RL	−40°C to +125°C	24-Lead LFCSP	CP-24-7	5,000				
ADA4940-2ACPZ-R7	-40°C to +125°C	24-Lead LFCSP	CP-24-7	1,500				

 $^{^{1}}$ Z = RoHS Compliant Part.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

<u>ADA4940-1ACPZ-R7</u> <u>ADA4940-1ARZ ADA4940-2ACPZ-R7</u> <u>ADA4940-1ACPZ-RL</u> <u>ADA4940-1ARZ-R7</u> <u>ADA4940-1ACPZ-R2</u> <u></u>